



PATENT

#511
2/23/02
JL

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Cobbley et al.

Serial No.: 09/639,486

Filed: August 14, 2000

For: METHOD OF ATTACHING SOLDER
BALLS TO BGA PACKAGE UTILIZING A
TOOL TO PICK AND DIP THE SOLDER
BALL IN FLUX

Examiner: Z. Pittman

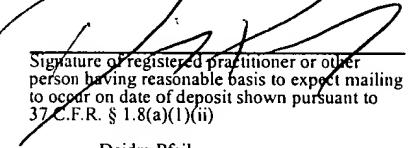
Group Art Unit: 1725

Attorney Docket No.: 3636.1US (97-1349.1)

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AMENDMENT

Box NON-FEE AMENDMENT
Commissioner for Patents
Washington, D.C. 20231

Sir:

This amendment is in response to the Office Action of October 31, 2001 whose initial period of response is set to expire on January 31, 2002.

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